

Ceramic Pressure Sensors Based on CrN Thin-films

CrN박막 세라믹 압력센서

Gwiy-Sang Chung*, Jeong-Hwan Seo**, GI-kyu Ryu**
(정 귀 상, 서 정 환, 류 지 구)

Abstract

The physical, electrical and piezoresistive characteristics of CrN(chromium nitride) thin-films on silicon substrates have been investigated for use as strain gauges. The thin-film depositions have been carried out by DC reactive magnetron sputtering in an argon-nitrogen atmosphere(Ar-(5~25 %)N₂). The deposited CrN thin-films with thickness of 3500Å and annealing conditions(300°C, 48 hr) in Ar-10 % N₂ deposition atmosphere have been selected as the ideal piezoresistive material for the strain gauges. Under optimum conditions, the CrN thin-films for the strain gauges is obtained a high electrical resistivity, $\rho = 1147.65 \mu \Omega \text{cm}$, a low temperature coefficient of resistance, TCR=-186 ppm/°C and a high temporal stability with a good longitudinal gauge factor, GF=11.17.

Key Words : chromium nitride, thin-film, strain gauge, temperature coefficient of resistance, gauge factor, hysteresis, aging effect, I/V/T curve

1. Introduction

Recently, pressure sensors with wide dynamic pressure ranges which can be used at high temperature, pressure, humidity, and vibration environments, are particularly demanded in automotive, aircraft-engine, industrial and laboratory pressure sensing instruments. Pressure sensors are basically electromechanical devices used for a variety of applications. A pressure sensor essentially consists of a diaphragm which undergoes deformation due to applied pressure. This mechanical deformation of the diaphragm

converted into an electrical response by strain gauges bonded to or piezoresistors diffused it.

To overcome the shortages mentioned above, thick-film, some kinds of metal alloys are used as materials for a high temperature or corrosive applications.⁽¹⁻⁷⁾ However, they have a low sensitivity because of a low gauge factor and a low electrical resistivity. They are difficult to be miniaturization. Conventional diffused semiconductor strain gauges have a high gauge factor and a high electrical resistivity, but they are limited in their use above 120°C. Other semiconductor materials like polysilicon,⁽⁸⁾ diamond,⁽⁹⁾ and SiC⁽¹⁰⁾ have been developed as strain gauges which can use in a high temperature, but they are impossible to have repeatability.

In order to develop the strain gauges with

*동서대학교 정보통신공학부,
(부산시 사상구 주례동 산69-1, FAX: 051-320-1592
E-mail : gschung@kowon.dongseo.ac.kr)

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wide dynamic pressure ranges which can be in harsh surroundings, thin-film strain gauges were investigated. Compared with conventional sensors, these devices have some advantages, such as a wide temperature range, excellent thermal compatibility with their substrates, and long-term stability, and are suitable for manufacturing miniaturized sensors with high internal resistance. Besides, they are characterized by the precisely-controlled technology and its advantages in batch manufacture. The distinct advantages are absence of adhesive material, flexibility to tailor the properties of the sensing film. Several ceramics have comparatively higher electrical resistance, stress sensitivity and gauge factor than metals. They have the possibility to use in a high temperature, and they are also available as materials of the thin-film strain gauges.⁽¹¹⁾

In this paper, we describe the physical, electrical and piezoresistive characteristics of CrN thin-films on silicon substrates for use as strain gauges. The CrN thin-films are deposited using by DC reactive magnetron sputtering in an argon-nitrogen atmosphere(Ar-(5~25 %)N₂). In order to improve the piezoresistive properties of the sensing element, deposition parameters and post-deposition thermal treatments have been chosen. The thin-film deposition and masking methods for the development of a sensing element based on piezoresistive CrN thin-films are also presented. Finally, under optimum conditions of deposition and annealing, this paper applies the I(current)/V(voltage)/T(time) curves of CrN thin-film strain gauges, hysteresis characteristics by changing in temperature and resistance, and aging effect to the ceramic thin-film strain gauges.

2. Experimental

CrN thin-films were deposited onto thermally oxidized 500 μm thick silicon substrates by DC reactive magnetron sputtering in an argon-nitrogen atmosphere(Ar-(5~25 %)N₂). Prior to the deposition, the silicon substrates were cleaned in an ultrasonic degreasing bath in clean-room

environment. The purity of metallic Cr target with diameter of 2-inch was 99.9%. The residual gas pressure was less than 5×10^{-6} Torr and the total gas pressure of the Ar-N₂ mixture during CrN deposition was held at 0.9 Torr. The Ar gas flow was 60~76 sccm, the N₂ gas flow 4~20 sccm. The deposition rates of 350~400 Å/min were achieved. A 7 W/cm² r.f bias was applied to the substrate during the deposition. Thin-film thickness between 1500 Å and 5000 Å were measured with a profilometer. A post-deposition thermal treatment(heat temperature ; 100~300°C and heat time; 24~72 hr) in an N₂ atmosphere was also carried out to investigate the annealing effect of the CrN thin-films. The structural and compositional properties of the CrN thin-films were evaluated by SEM(scanning electron microscope), XRD(x-ray diffraction) and EDS(electronic diffraction spectroscopy). All the electrical measurements were made by four-point probe methods.

The CrN thin-film resistors, 35 μm wide and with a 32 mm long meandering path, were patterned using photolithographic techniques. An automatic data-acquisition system controlled by a personal computer was used for the TCR(temperature coefficient of resistance) measurement in the range 25~150°C. Accelerated life tests at 150°C were made to study the long-term stability of CrN thin-film resistors. I/V/T characteristics were used to analyze the electrical conduction mechanism of the CrN thin-films. The longitudinal gauge factor of the CrN thin-films was determined using the cantilever beam method. The hysteresis effect due to strain cycling was also examined.

3. Results and Discussion

Fig. 1 shows TCR values according to annealing condition of CrN thin-film strain gauges for N₂ rate. The more annealing temperature increased, TCR values decreased. When N₂ rate was 4~8 sccm, the variation width was the widest, that is, it seemed to reach the lowest TCR values in N₂ rate of 4~8 sccm,

annealing temperature of 300°C and annealing times of 48 hr. And when N₂ rate was more than 16 sccm, by annealing temperature more than 300°C it could not be measured because resistance rate increased. Therefore, comparatively a high electrical resistivity value and a low TCR value of -186 ppm/°C were given in N₂ rate of 8 sccm and annealing conditions which were heat temperature of 300°C and heat times of 48 hr. The electrical resistivity in this situation is $\rho = 1147.65 \mu \Omega \text{ cm}$.

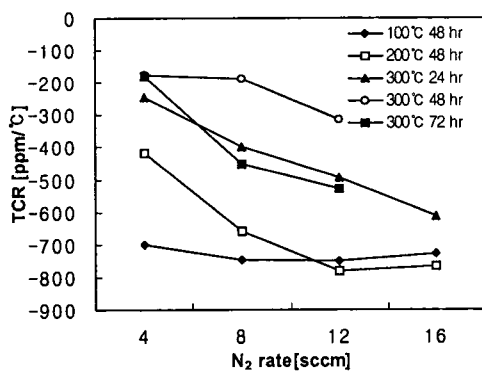


Fig. 1. TCR values according to annealing condition of CrN thin-film strain gauges (heat temperature : 100~ 300°C, heat times : 24~72 hr).

Fig. 2 shows hysteresis characteristics of the variation rate of resistance according to temperature of CrN thin-film strain gauges in the temperature range of 25~150°C when N₂ rate is 8 sccm and annealing conditions are heat temperature of 300°C and heat time of 48 hr. It showed a nonlinearity and a hysteresis less than 1.65 % FS and 2.27 % FS, respectively. The TCR shows a high linearity and a low hysteresis under this conditions. Variation rate of resistance according to temperature was very linear, and it seemed to get more stable characteristics according to annealing.

Fig. 3 shows the long-term stability according to times in temperature from an accelerated life test at 150°C of CrN thin-film strain gauges, when N₂ rate is 8 sccm, annealing conditions are heat temperature of 300°C and heat time of 48 hr. The resistance variation rate is very small for

CrN thin-film strain gauges, $\Delta R/\Delta t = \pm 6 \text{ ppm/h}$. this implies that the temporal stability is good.

Fig. 4 shows I/V/T characteristics of CrN thin-films deposited in N₂ rate of 8 sccm and annealed at heat temperature of 300°C and heat

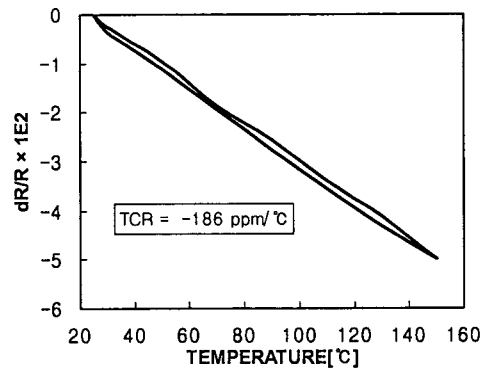


Fig. 2. Variation rate of resistance according to temperature of CrN thin-film strain gauges (N₂ rate : 8 sccm, annealing condition : 300°C, 48 hr).

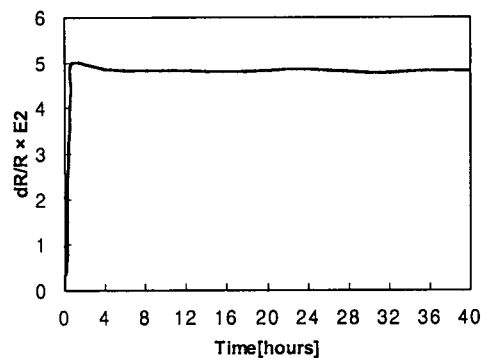


Fig. 3. Aging effect of CrN thin-film strain gauges (N₂ rate : 8 sccm, annealing condition : 300°C, 48 hr).

time of 48 hr. The resistance is held constant during the test. This phenomenon is in agreement with a metallic conduction mechanism. The high resistivity and the negative TCR values of CrN thin-films indicate that the conduction electron mean free path is very small.⁽¹¹⁾ It is believed that the high scatter in this type of material is caused by a large amount of disorder due to the

amorphous structure of these CrN thin-films. The metallic conduction mechanism indicates the existence of a continuous metallic phase.

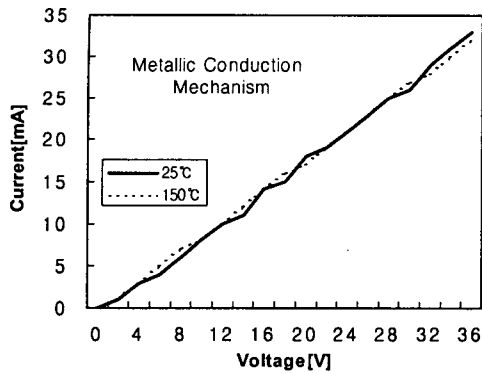


Fig. 4. I/V/T Characteristics of CrN thin-films(N_2 rate : 8sccm, annealing condition : 300°C, 48hr).

Fig. 5 shows variations of longitudinal gauge factor of CrN thin-film strain gauges according to annealing conditions. As annealing temperature and times increased, gauge factor kept regularly without high variations. The more N_2 rate increased, the more gauge factor of CrN thin-film strain gauges increased. It seems to not give many effects in sensitivity of strain gauges by annealing.

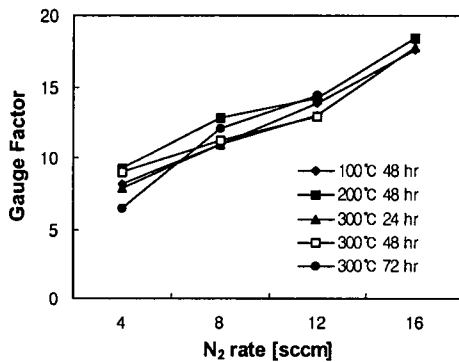


Fig. 5. Variations of gauge factor according to annealing condition of CrN thin-film strain gauges(heat temperature : 100~ 300°C, heat times : 24~72 hr).

4. Conclusions

The physical, electrical and piezoresistive characteristics of CrN thin-films on silicon substrates for use as strain gauges were studied. The CrN thin-films were deposited using by DC reactive magnetron sputtering in an argon-nitrogen atmosphere($Ar-(5\sim 25\%)N_2$). The sputtering and annealing conditions have been defined in order to optimize the piezoresistive properties of the sensing element. Optimum conditions of CrN thin-film strain gauges were thickness of 3500Å and annealing conditions of 300°C and 48 hr, and N_2 rate of 8 sccm. CrN thin-films for strain gauges were obtained electrical resistivity of 1147.65 $\mu\Omega\text{cm}$, TCR = -186 ppm/°C and longitudinal gauge factor of 11.17 at optimum conditions. A metallic conduction mechanism has been identified in the deposited CrN thin-films. These properties of CrN thin-film strain gauges are very useful application as mechanical sensors.

5. Reference

- [1] P. Kayser et al., Sensors & Actuators A 37 (1993)328.
- [2] I. Obieta et al., Sensors & Actuators 41(1994) 521.
- [3] I. Ayerdi et al., Sensors & Actuators A 46 (1995)218.
- [4] K. Rajanna et al., Trans. Electron Devices 40 (1993)521.
- [5] K. Rajanna et al., Sensors & Actuators A 24 (1990)35.
- [6] W. Hongye et al., Sensors & Actuators 35 (1993)265.
- [7] S. Sampath et al., Thin Solid Films 137 (1986)199.
- [8] H. Konishi et al., Tech. Digest of the 9th sensor sympo. (1990)149.
- [9] Y. Onuma et al., Sensors & Actuators 13 (1988)71.
- [10] Y. Onuma et al., Sensors & Materials 2 (1991)207.
- [14] Y. Tanaka et al., Thin Solid Film 240(1991) 238.